e2v technologies

CCD67 Back Illuminated AIMO High Performance Compact Pack CCD Sensor

FEATURES

- 256 x 256 Pixel Image Area.
- 26 μm Square Pixels.
- Low Noise, High Responsivity Output Amplifier.
- 100% Active Area.
- Gated Dump Drain on Output Register.
- Low Dark Current

INTRODUCTION

This version of the CCD67 family of CCD sensors is a frame transfer imaging device with a single serial output register.

There are two low noise amplifiers in the readout register, one at each end. Charge can be made to transfer through either or both of the amplifiers by making the appropriate RØ connections. The readout register has a gate controlled dump drain to allow fast dumping of unwanted data.

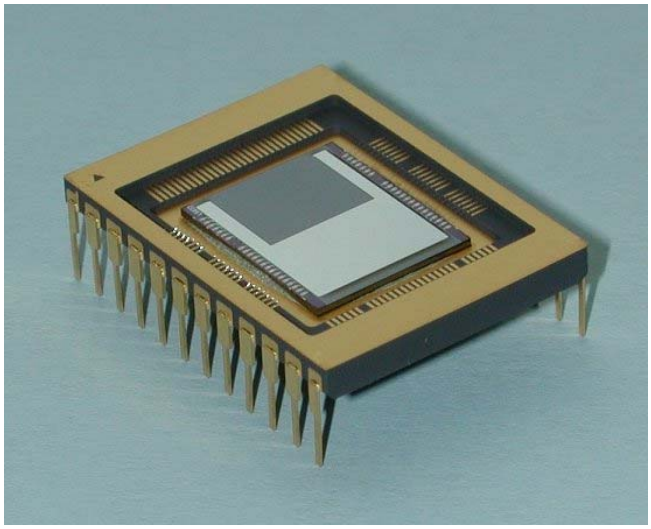
The register is designed to accommodate 3 image pixels of charge.

The CCD67 is pin compatible with the CCD57 and the centre of the image area of the CCD67 is coincident with that of the CCD57.

Other variants of the CCD67 are available for applications with differing requirements. Designers are advised to contact e2v technologies should they be considering the use of CCD sensors in abnormal environments or if they require customised packaging.

TYPICAL PERFORMANCE

Maximum readout frequency	5	MHz
Output responsivity	1.5	$\mu V/e^-$
Peak signal	450	ke^-/pixel
Spectral range	200 - 1100	nm
Readout noise (1 MHz)	12	e^- rms



GENERAL DATA

Format

Image area pixels	268 (H) x 264 (V)
Active area pixels	256 (H) x 256 (V)
Storage area pixels	268 (H) x 264 (V)
Pixel size	26 x 26 μm
Number of output amplifiers	2
Number of underscan (serial) pixels	6 (each end)

Package

Package size	30.0 x 22.6 mm
Number of pins	32
Inter-pin spacing	2.54 mm
Window material	temporary coverglass
Package type	ceramic DIL array

e2v technologies (uk) limited, Waterhouse Lane, Chelmsford, Essex CM1 2QU, UK Telephone: +44 (0)1245 493493 Facsimile: +44 (0)1245 492492
e-mail: enquiries@e2v.com Internet: www.e2v.com Holding Company: e2v technologies plc

e2v technologies inc. 4 Westchester Plaza, PO Box 1482, Elmsford, NY10523-1482 USA Telephone: (914) 592-6050 Facsimile: (914) 592-5148
e-mail: enquiries@e2vtechnologies.us

A1A-100004 Issue 1, April 2005

411/8891

PERFORMANCE

	Min	Typical	Max	
Peak charge storage (see note 1)	300k	450k	-	e^-/pixel
Peak output voltage (no binning)	-	0.9	-	V
Dark signal at 293 K (see note 2)	-	1700	4000	e^-/pixel/s
Dynamic range (see note 3)	-	112 500:1	-	
Charge transfer efficiency (see note 4):				
parallel	-	99.9999	-	%
serial	-	99.9993	-	%
Output amplifier responsivity	1.0	1.5	2.0	$\mu V/e^-$
Readout noise at 233 K (20 kHz) (see note 5)	-	4.0	6.0	rms e^-
Maximum readout frequency (see note 6)	-	-	5	MHz
Maximum vertical transfer frequency	-	-	2	MHz
Photo response non-uniformity (see note 7) (std. deviation)	-	3	5	% of mean
Dark signal non-uniformity (293 K) (see note 8)	-	425	1000	e^-/pixel/s

NOTES

1. Signal level at which resolution begins to degrade.
2. Measured between 233 and 253 K and V_{SS} +9.0 V. Dark signal at any temperature T (kelvin) may be estimated from:
   $$Q_d/Q_{d0} = 1.14 \times 10^6 T^3 e^{-9080/T}$$
   where Q_{d0} is the dark signal at T = 293 K (20 °C).
3. Dynamic range is the ratio of full-well capacity to readout noise measured at 233 K and 20 kHz readout speed.
4. CCD characterisation measurements made using charge generated by X-ray photons of known energy.
5. Measured using a dual-slope integrator technique (i.e. correlated double sampling) with a 10 µs integration period.
6. Readout at speeds in excess of 5 MHz into a 15 pF load can be achieved but performance to the parameters given cannot be guaranteed.
7. This is not quoted for the fibre-optic variant as it is affected by the fibre-optic.
8. Measured between 253 and 293 K, excluding white defects.

BLEMISH SPECIFICATION

Traps Pixels where charge is temporarily held. Traps are counted if they have a capacity greater than 200 e^- at 233 K.

Slipped columns Are counted if they have an amplitude greater than 200 e^-.

Black spots Are counted when they have a signal level of less than 90% of the local mean at a signal level of approximately half full-well.

White spots Are counted when they have a generation rate 10 times the specified maximum dark signal generation rate (measured between 253 and 293 K). The amplitude of white spots will vary in the same manner as dark current, i.e.:
$$Q_d/Q_{d0} = 122T^3 e^{-6400/T}$$

White column A column which contains at least 9 white defects.

Black column A column which contains at least 9 black defects.

GRADE	0	1	2
Column defects:			
black or slipped	0	1	4
white	0	0	0
Black spots	5	10	20
Traps > 200 e^-	1	2	5
White spots	5	10	15

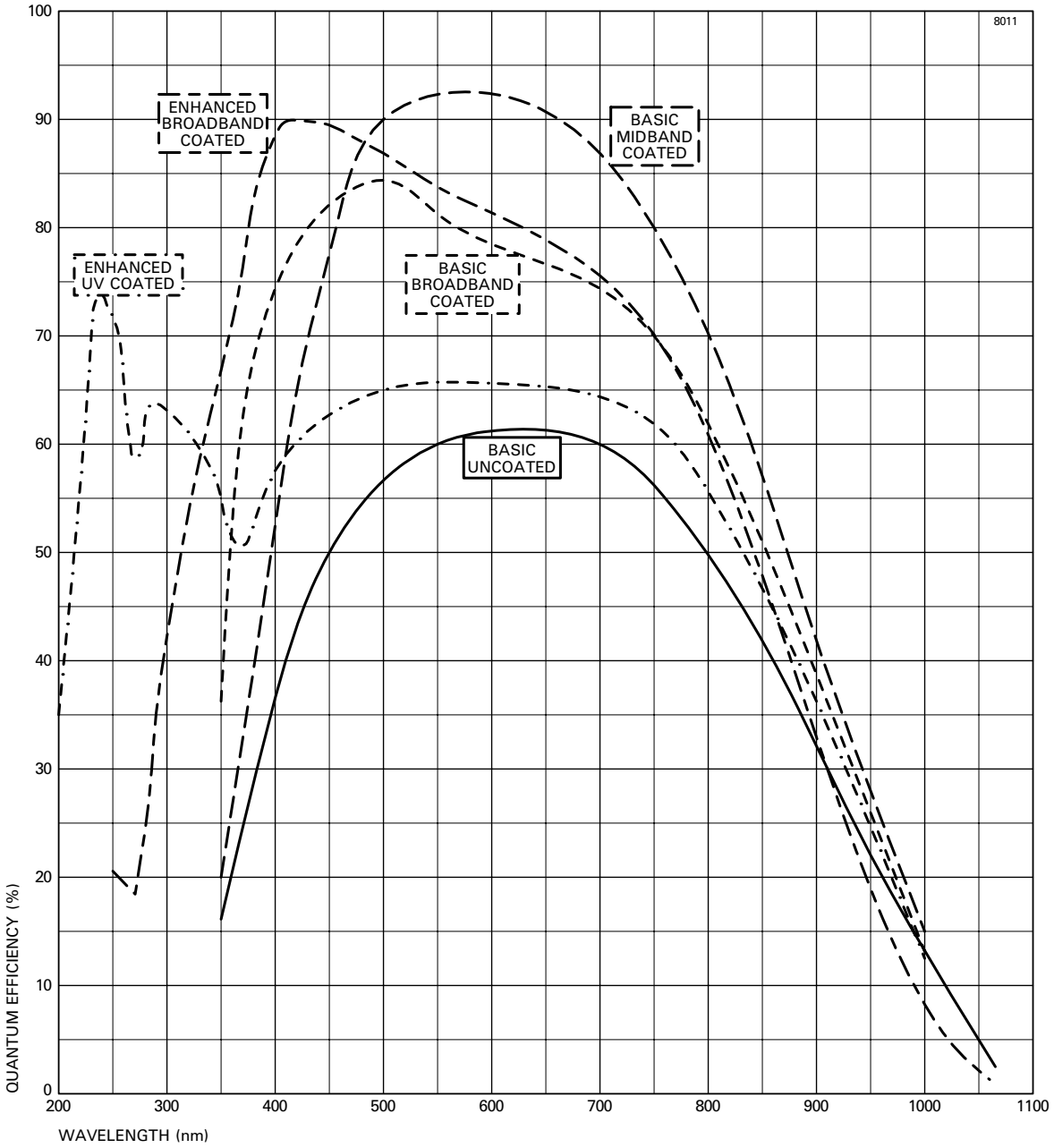
Grade 5 Devices which are fully functioning, with image quality below that of grade 2, and which may not meet all other performance parameters.

Minimum separation between
adjacent black columns . . . . . 50 pixels

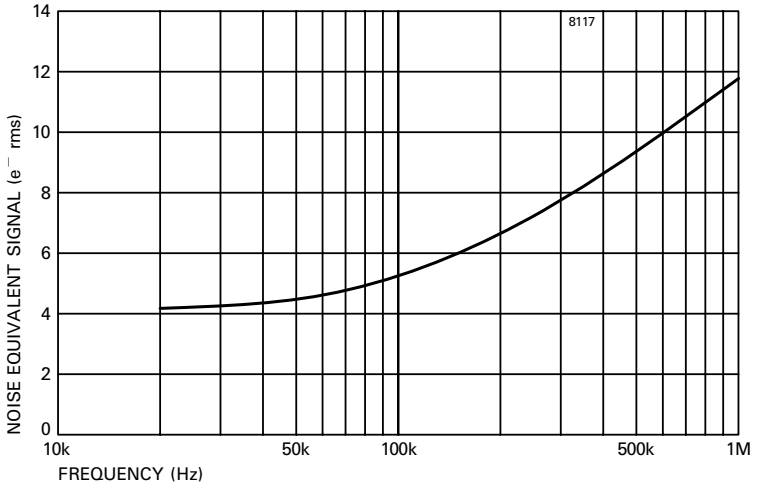
Note The effect of temperature on defects is that traps will be observed less at higher temperatures but more may appear below 253 K. The amplitude of white spots and columns will decrease rapidly with temperature.

TYPICAL SPECTRAL RESPONSE

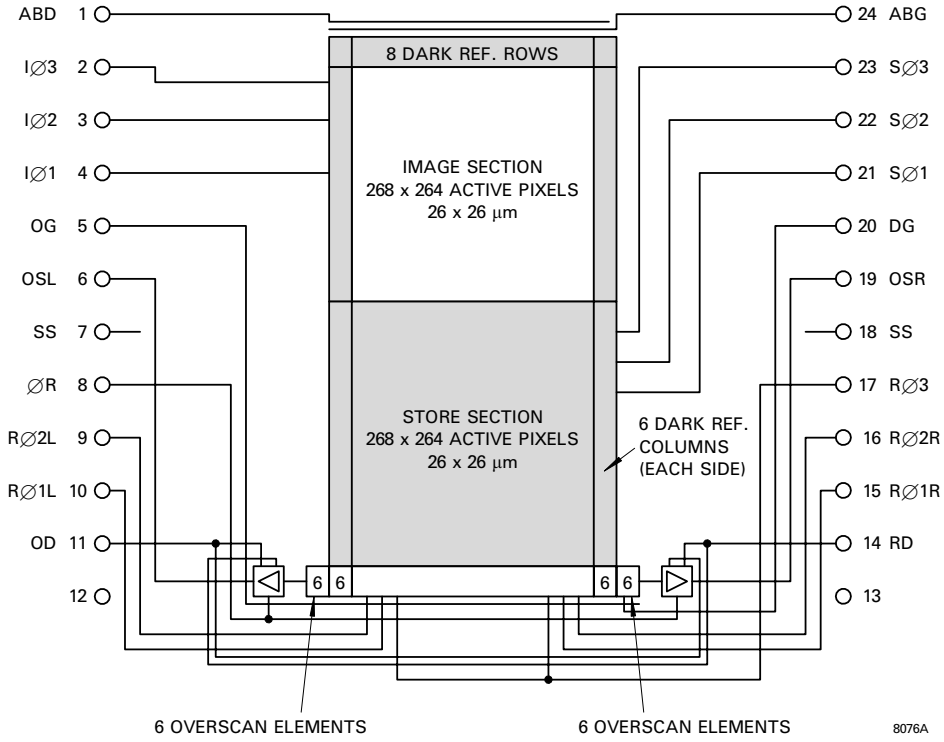
The spectral response will depend on the cooling applied to the device.



TYPICAL OUTPUT NOISE



DEVICE SCHEMATIC



CONNECTIONS, TYPICAL VOLTAGES AND ABSOLUTE MAXIMUM RATINGS

PIN	REF	DESCRIPTION	CLOCK LOW (V typ.)	CLOCK HIGH OR DC LEVEL (V)			MAXIMUM RATINGS w.r.t. V_{SS}
				Min	Typical	Max	
1	ABD	Anti-blooming drain (see note 9)	n/a		V_{OD}		−0.3 to +25 V
2	IØ3	Image area clock, phase 3	0	8	12	15	±20 V
3	IØ2	Image area clock, phase 2	0	8	12	15	±20 V
4	IØ1	Image area clock, phase 1	0	8	12	15	±20 V
5	OG	Output gate	n/a	1	3	5	±20 V
6	OSL	Output transistor source (left amplifier)	n/a		see note 10		−0.3 to +25 V
7	SS	Substrate	n/a	0	9.5	11	-
8	ØR	Reset pulse	0	8	12	15	±20 V
9	RØ2L	Register clock, phase 2 (left section)	−2	8	10	15	±20 V
10	RØ1L	Register clock, phase 1 (left section)	−2	8	10	15	±20 V
11	OD	Output drain	n/a	27	29	31	−0.3 to +25 V
12	-	No connection	n/a		-		-
13	-	No connection	n/a		-		-
14	RD	Reset drain	n/a	15	18	21	−0.3 to +25 V
15	RØ1R	Register clock, phase 1 (right section)	−2	8	10	15	±20 V
16	RØ2R	Register clock, phase 2 (right section)	−2	8	10	15	±20 V
17	RØ3	Register clock, phase 3	−2	8	10	15	±20 V
18	SS	Substrate	n/a	0	9.5	11	-
19	OSR	Output transistor source (right amplifier)	n/a		see note 10		−0.3 to +25 V
20	DG	Dump gate (see note 11)	0	10	12	14	±20 V
21	SØ1	Storage clock, phase 1	0	8	12	15	±20 V
22	SØ2	Storage clock, phase 2	0	8	12	15	±20 V
23	SØ3	Storage clock, phase 3	0	8	12	15	±20 V
24	ABG	Anti-blooming gate (see note 9)	n/a	0	3	5	±20 V

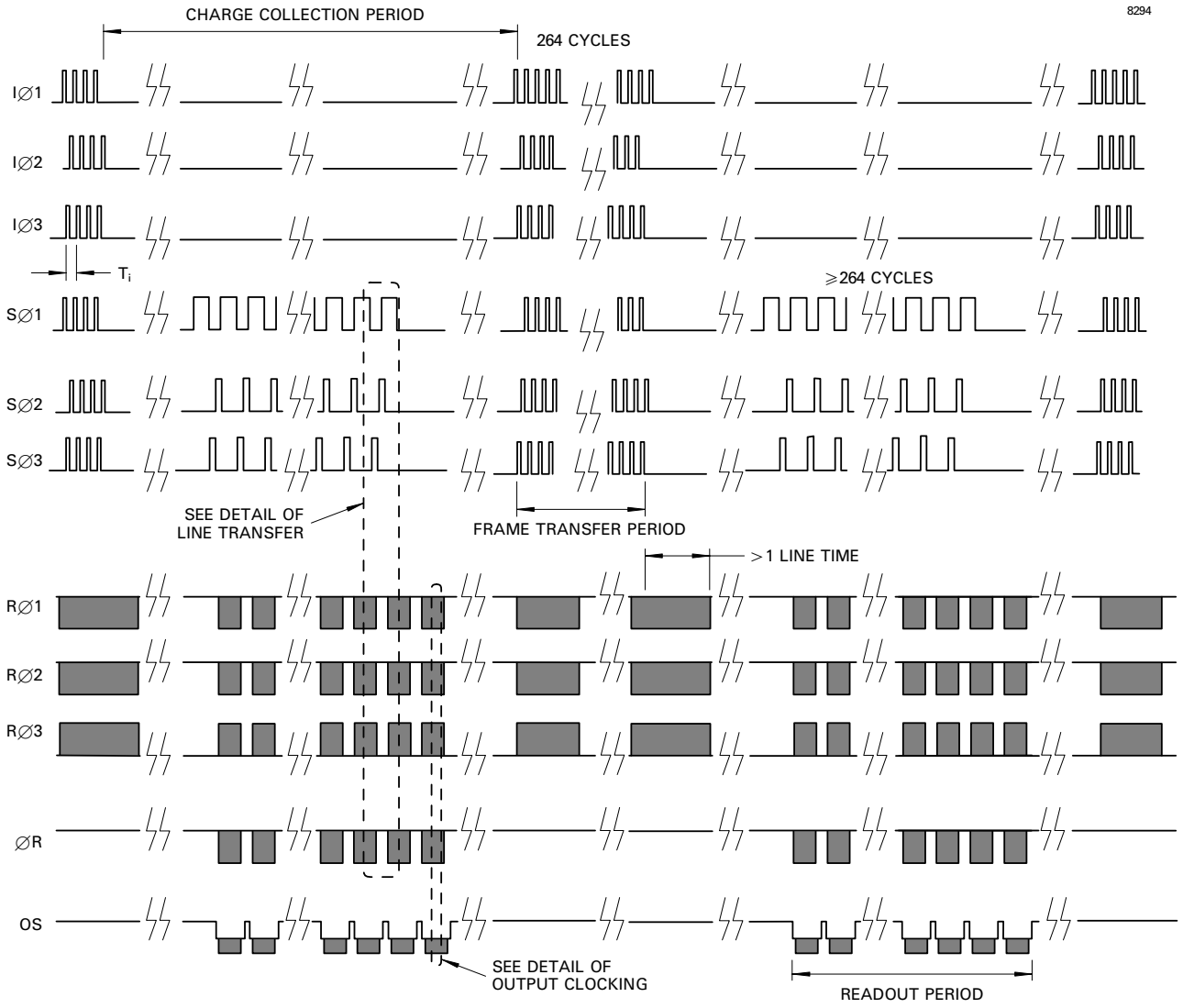
NOTES

9. Although anti-blooming is not incorporated, bias is still necessary.

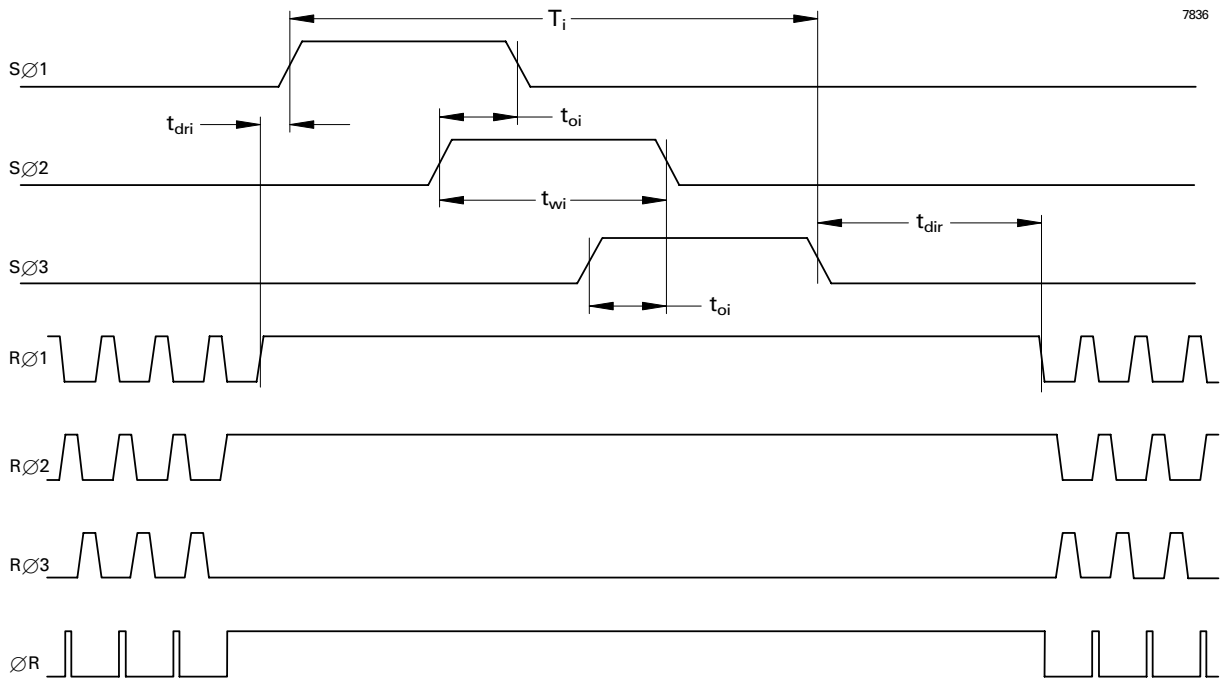
10. 3 to 5 V below OD. Connect to ground using a 2 to 5 mA current source or appropriate load resistor (typically 5 to 10 kΩ).

11. This gate is normally low. It should be pulsed high for charge dump.

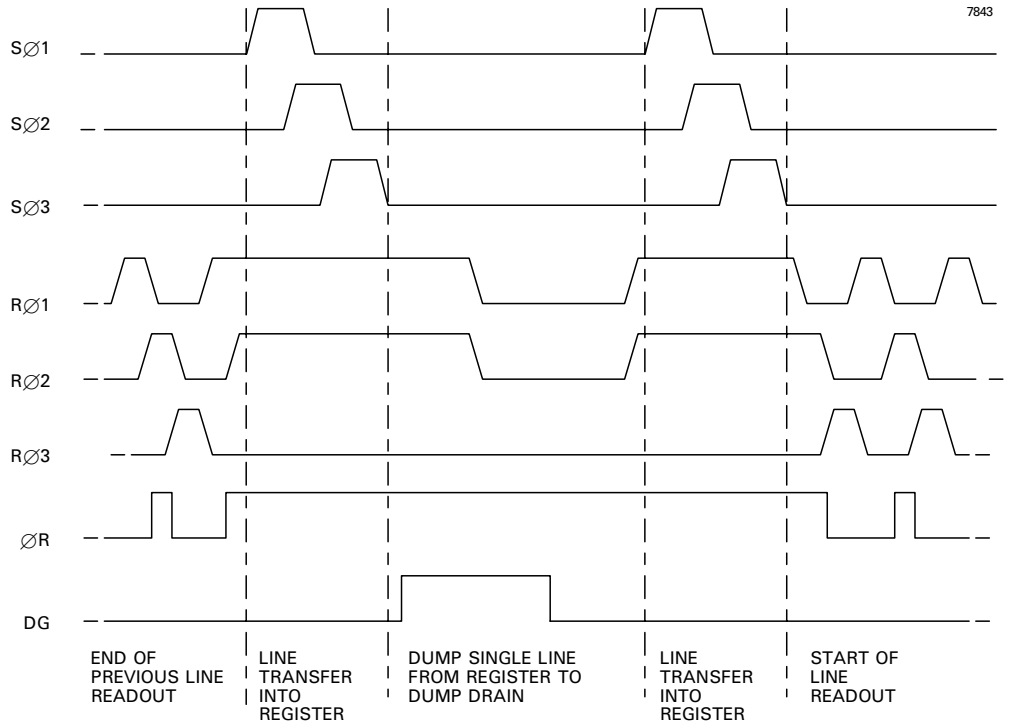
FRAME TRANSFER TIMING DIAGRAM



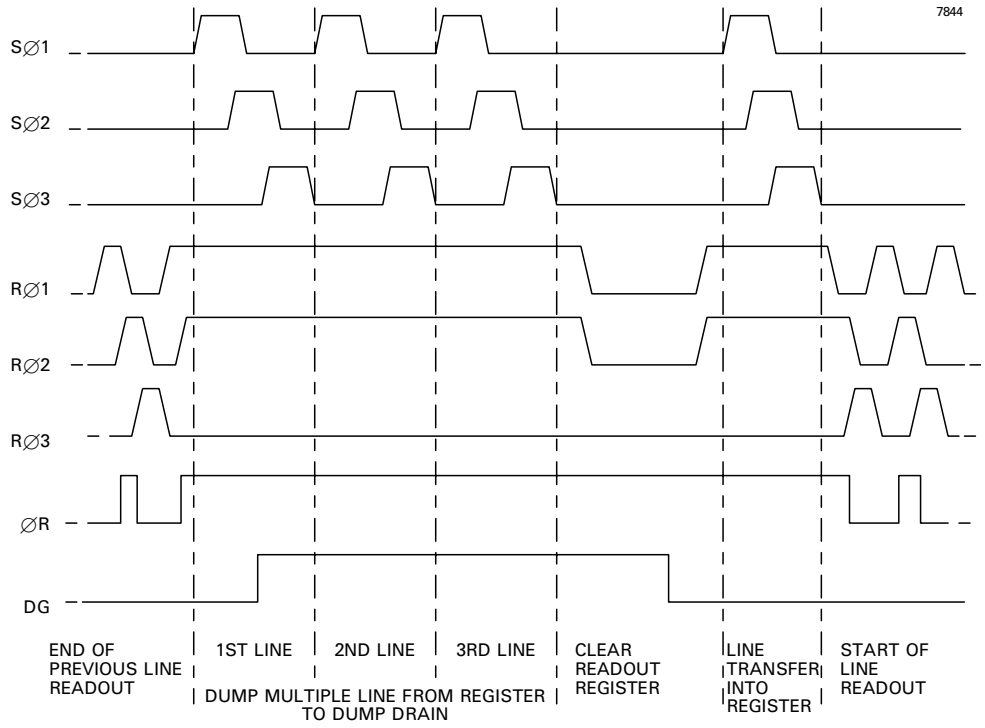
DETAIL OF LINE TRANSFER



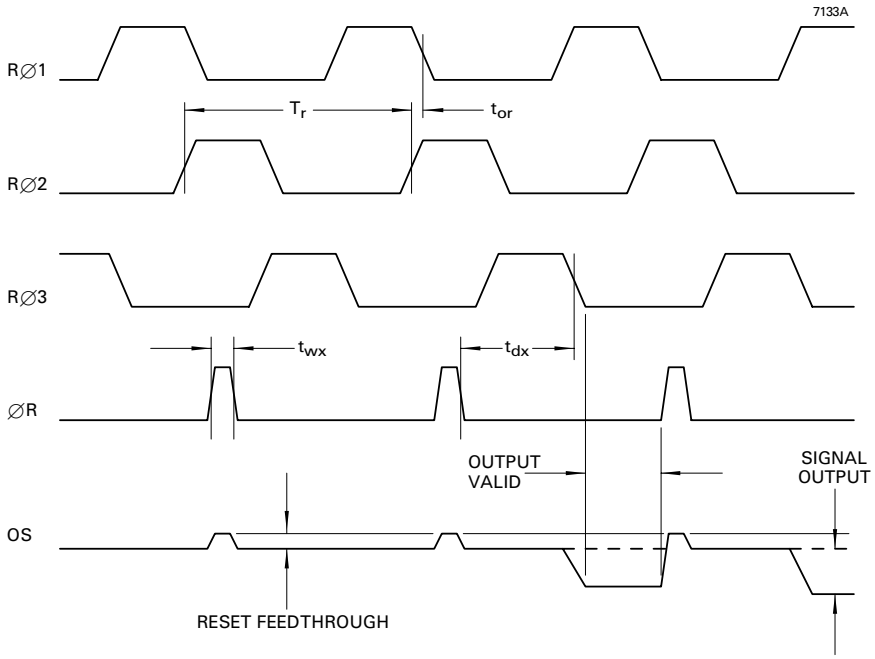
DETAIL OF VERTICAL LINE TRANSFER (Single line dump)



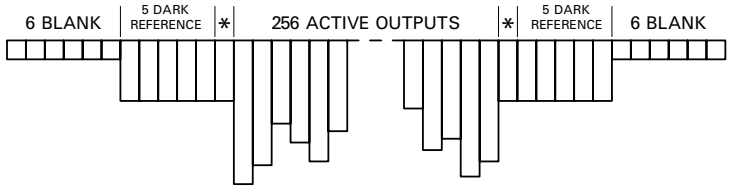
DETAIL OF VERTICAL LINE TRANSFER (Multiple line dump)



DETAIL OF OUTPUT CLOCKING



LINE OUTPUT FORMAT



* = Partially shielded transition elements

8120

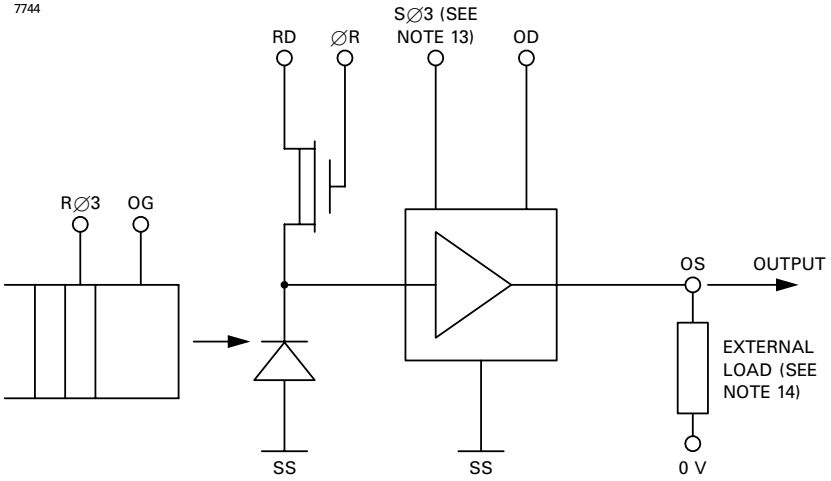
CLOCK TIMING REQUIREMENTS

Symbol	Description	Min	Typical	Max	
T_{fi}	First frame transfer pulse width	100	150	see note 12	µs
T_{ti}	Frame transfer clock period	2	5	see note 12	µs
t_{wti}	Frame transfer image clock pulse width	1	2	$T_{ti}/3 + t_{oi}$	µs
T_i	Store clock period	25	50	see note 12	µs
t_{wi}	Image/store clock pulse width	8	16	see note 12	µs
t_{ri}	Image/store clock pulse rise time (10 to 90%)	0.03	0.1	$0.2T_{ti}$	µs
t_{fi}	Image/store clock pulse fall time (10 to 90%)	t_{ri}	0.1	$0.2T_{ti}$	µs
t_{oi}	Image/store clock pulse overlap	0.2	0.3	$0.2T_{ti}$	µs
t_{dir}	Delay time, SØ stop to RØ start	1	2	see note 12	µs
t_{dri}	Delay time, RØ stop to SØ start	1	1	see note 12	µs
T_r	Output register clock cycle period	200	1000	see note 12	ns
t_{rr}	Clock pulse rise time (10 to 90%)	50	$0.1T_r$	$0.3T_r$	ns
t_{fr}	Clock pulse fall time (10 to 90%)	t_{rr}	$0.1T_r$	$0.3T_r$	ns
t_{or}	Clock pulse overlap	20	$0.5t_{rr}$	$0.1T_r$	ns
t_{wx}	Reset pulse width	30	$0.1T_r$	$0.3T_r$	ns
t_{rx}, t_{fx}	Reset pulse rise and fall times	$0.2t_{wx}$	$0.5t_{rr}$	$0.1T_r$	ns
t_{dx}	Delay time, ØR low to RØ3 low	30	$0.5T_r$	$0.8T_r$	ns

NOTES

12. No maximum other than that necessary to achieve an acceptable dark signal at the longer readout times.

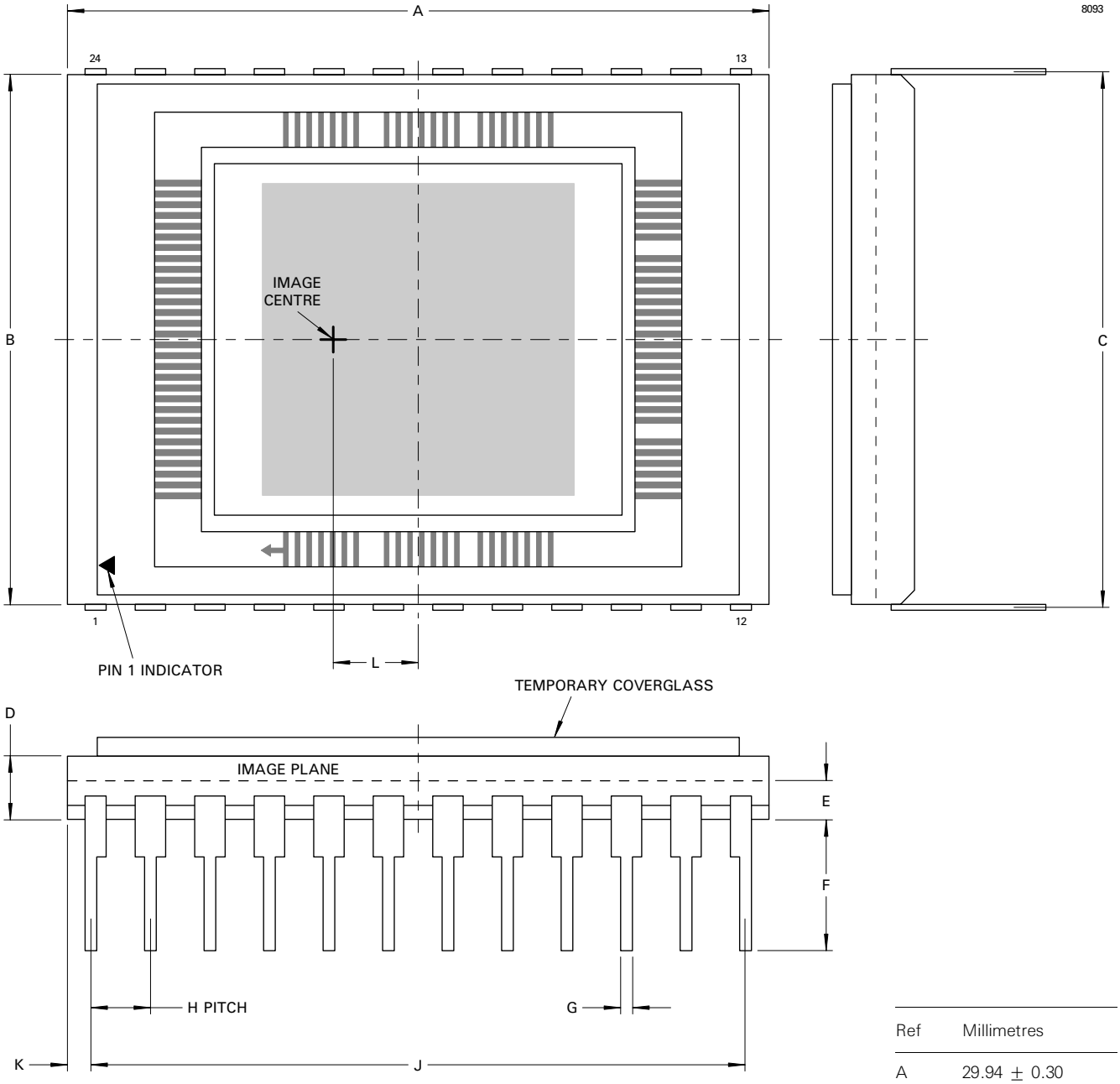
OUTPUT CIRCUIT (Right-hand amplifier)



NOTES

13. The amplifier has a DC restoration circuit which is internally activated whenever S∅3 is high.
14. Not critical; can be a 2 to 5 mA constant current supply or an appropriate load resistor.

OUTLINE
(All dimensions without limits are nominal)



Ref	Millimetres
A	29.94 ± 0.30
B	22.61 ± 0.25
C	22.86 ± 0.25
D	2.70 ± 0.27
E	1.65 ± 0.25
F	5.6 ± 0.5
G	0.46 ± 0.05
H	2.54 ± 0.13
J	27.94 ± 0.13
K	1.0 ± 0.3
L	3.62

